

MC10E336, MC100E336

5V ECL 3-Bit Registered Bus Transceiver

The MC10E/MC100E336 contains three bus transceivers with both transmit and receive registers. The bus outputs (BUS0–BUS2) are specified for driving a 25 Ω bus; the receive outputs (Q0–Q2) are specified for 50 Ω. The bus outputs feature a normal HIGH level (V_{OH}) and a cutoff LOW level — when LOW, the outputs go to –2.0 V and the output emitter-follower is “off”, presenting a high impedance to the bus. The bus outputs also feature edge slow-down capacitors.

The Transmit Enable pins (TEN) control whether current data is held in the transmit register, or new data is loaded from the A/B inputs. A LOW on both of the Bus Enable inputs (BUSEN), when clocked through the register, disables the bus outputs to –2.0 V.

The receiver section clocks bus data into the receive registers, after gating with the Receive Enable (\overline{RXEN}) input.

All registers are clocked by a positive transition of CLK1 or CLK2 (or both).

Additional leadframe grounding is provided through the Ground pins (GND) which should be connected to 0 V. The GND pins are not electrically connected to the chip.

The 100 Series contains temperature compensation.

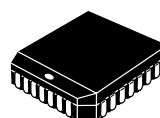
- 25 Ω Cutoff Bus Outputs
- 50 Ω Receiver Outputs
- Transmit and Receive Registers
- 1500 ps Max. Clock to Bus
- 1000 ps Max. Clock to Q
- Bus Outputs Feature Internal Edge Slow-Down Capacitors
- Additional Package Ground Pins
- PECL Mode Operating Range: V_{CC} = 4.2 V to 5.7 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = –4.2 V to –5.7 V
- Internal Input Pulldown Resistors
- ESD Protection: > 1 KV HBM, > 75 V MM
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1
For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL–94 code V–0 @ 1/8”, Oxygen Index 28 to 34
- Transistor Count = 430 devices



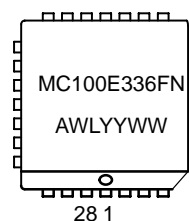
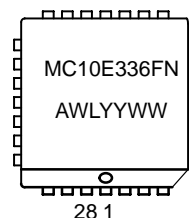
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MARKING DIAGRAMS



PLCC–28
FN SUFFIX
CASE 776



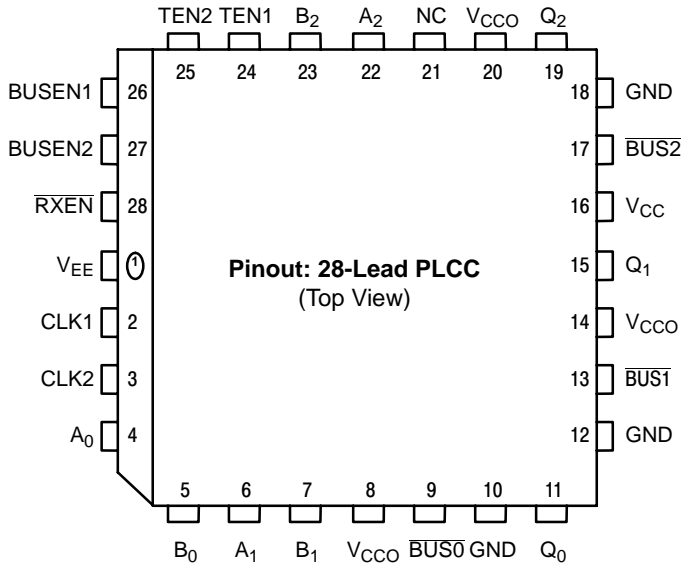
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

ORDERING INFORMATION

| Device | Package | Shipping |
|---------------|---------|----------------|
| MC10E336FN | PLCC–28 | 37 Units/Rail |
| MC10E336FNR2 | PLCC–28 | 500 Units/Reel |
| MC100E336FN | PLCC–28 | 37 Units/Rail |
| MC100E336FNR2 | PLCC–28 | 500 Units/Reel |

MC10E336, MC100E336

LOGIC DIAGRAM AND PINOUT ASSIGNMENT



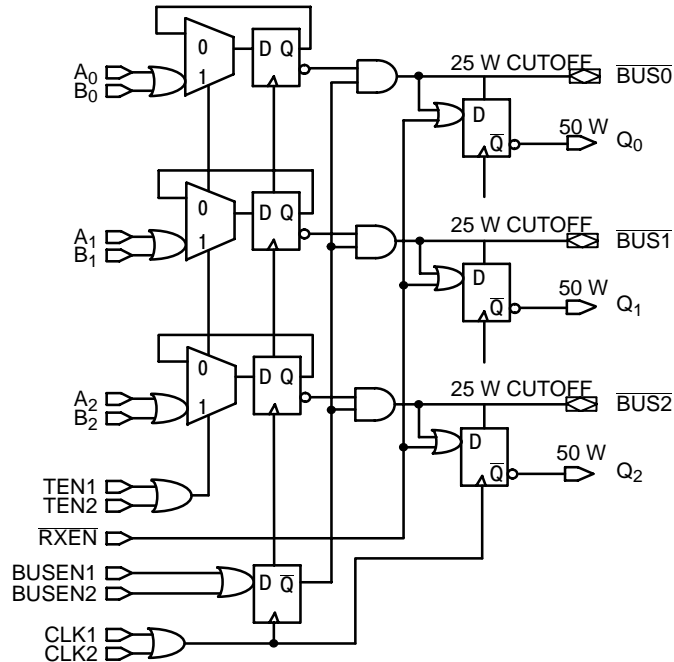
PIN DESCRIPTION

| PIN | FUNCTION |
|------------------------------------|--------------------|
| TEN1, TEN2 | ECL Transit Enable |
| A0–A2 | ECL Data Inputs A |
| B0–B2 | ECL Data Inputs B |
| Q0–Q1 | ECL Output |
| BUSEN1, BUSEN2 | ECL Bus Enables |
| BUS0–BUS2 | ECL Bus Outputs |
| RXEN | ECL Receive Enable |
| CLK1, CLK2 | ECL Clock Input |
| V _{CC} , V _{CCO} | Positive Supply |
| V _{EE} | Negative Supply |
| GND | Ground |
| NC | No Connect |

* All V_{CC} and V_{CCO} pins are tied together on the die.

Warning: All V_{CC}, V_{CCO}, and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

LOGIC DIAGRAM



MC10E336, MC100E336

MAXIMUM RATINGS (Note 1.)

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Units |
|------------------|--|--|--|----------------------------|--------------|
| V _{CC} | PECL Mode Power Supply | V _{EE} = 0 V | | 8 | V |
| V _{EE} | NECL Mode Power Supply | V _{CC} = 0 V | | -8 | V |
| V _I | PECL Mode Input Voltage NECL Mode Input Voltage | V _{EE} = 0 V V _{CC} = 0 V | V _I ≤ V _{CC} V _I ≥ V _{EE} | 6 -6 | V V |
| I _{out} | Output Current | Continuous Surge | | 50 100 | mA mA |
| T _A | Operating Temperature Range | | | 0 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| θ _{JA} | Thermal Resistance (Junction to Ambient) | 0 LFPM 500 LFPM | 28 PLCC 28 PLCC | 63.5 43.5 | °C/W °C/W |
| θ _{JC} | Thermal Resistance (Junction to Case) | std bd | 28 PLCC | 22 to 26 | °C/W |
| V _{EE} | PECL Operating Range NECL Operating Range | | | 4.2 to 5.7 -5.7 to -4.2 | V V |
| T _{sol} | Wave Solder | <2 to 3 sec @ 248°C | | 265 | °C |

1. Maximum Ratings are those values beyond which device damage may occur.

10E SERIES PECL DC CHARACTERISTICS V_{CCX}= 5.0 V; V_{EE}= 0.0 V (Note 1.)

| Symbol | Characteristic | 0°C | | | 25°C | | | 85°C | | | Unit |
|------------------|--|------|------|------------|------|------|------------|------|------|------------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I _{EE} | Power Supply Current | | 125 | 150 | | 125 | 150 | | 125 | 150 | mA |
| V _{OH} | Output HIGH Voltage (Note 2.) | 3980 | 4070 | 4160 | 4020 | 4105 | 4190 | 4090 | 4185 | 4280 | mV |
| V _{OL} | Output LOW Voltage (Note 2.) | 3050 | 3210 | 3370 | 3050 | 3210 | 3370 | 3050 | 3227 | 3405 | mV |
| V _{IH} | Input HIGH Voltage | 3830 | 3995 | 4160 | 3870 | 4030 | 4190 | 3940 | 4110 | 4280 | mV |
| V _{IL} | Input LOW Voltage | 3050 | 3285 | 3520 | 3050 | 3285 | 3520 | 3050 | 3302 | 3555 | mV |
| V _{CUT} | Cut-off Output Voltage (Note 2.) | 2.9 | | 2.97 | 2.9 | | 2.97 | 2.9 | | 2.97 | V |
| I _{IH} | Input HIGH Current RXEN All Other Inputs | | | 225 150 | | | 225 150 | | | 225 150 | μA |
| I _{IL} | Input LOW Current | 0.5 | 0.3 | | 0.5 | 0.25 | | 0.3 | 0.2 | | μA |

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.46 V / -0.06 V.
- Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

10E SERIES NECL DC CHARACTERISTICS V_{CCX}= 0.0 V; V_{EE}= -5.0 V (Note 1.)

| Symbol | Characteristic | 0°C | | | 25°C | | | 85°C | | | Unit |
|------------------|--|-------|-------|------------|-------|-------|------------|-------|-------|------------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I _{EE} | Power Supply Current | | 125 | 150 | | 125 | 150 | | 125 | 150 | mA |
| V _{OH} | Output HIGH Voltage (Note 2.) | -1020 | -930 | -840 | -980 | -895 | -810 | -910 | -815 | -720 | mV |
| V _{OL} | Output LOW Voltage (Note 2.) | -1950 | -1790 | -1630 | -1950 | -1790 | -1630 | -1950 | -1773 | -1595 | mV |
| V _{IH} | Input HIGH Voltage | -1170 | -1005 | -840 | -1130 | -970 | -810 | -1060 | -890 | -720 | mV |
| V _{IL} | Input LOW Voltage | -1950 | -1715 | -1480 | -1950 | -1715 | -1480 | -1950 | -1698 | -1445 | mV |
| V _{CUT} | Cut-off Output Voltage (Note 2.) | 2.9 | | 2.97 | 2.9 | | 2.97 | 2.9 | | 2.97 | V |
| I _{IH} | Input HIGH Current RXEN All Other Inputs | | | 225 150 | | | 225 150 | | | 225 150 | μA |
| I _{IL} | Input LOW Current | 0.5 | 0.3 | | 0.5 | 0.065 | | 0.3 | 0.2 | | μA |

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.46 V / -0.06 V.
- Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

MC10E336, MC100E336

100E SERIES PECL DC CHARACTERISTICS $V_{CCx}=5.0\text{ V}$; $V_{EE}=0.0\text{ V}$ (Note 1.)

| Symbol | Characteristic | 0°C | | | 25°C | | | 85°C | | | Unit |
|-----------|--|------|------|------------|------|------|------------|------|------|------------|---------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I_{EE} | Power Supply Current | | 125 | 150 | | 125 | 150 | | 144 | 173 | mA |
| V_{OH} | Output HIGH Voltage (Note 2.) | 3975 | 4050 | 4120 | 3975 | 4050 | 4120 | 3975 | 4050 | 4120 | mV |
| V_{OL} | Output LOW Voltage (Note 2.) | 3190 | 3295 | 3380 | 3190 | 3255 | 3380 | 3190 | 3260 | 3380 | mV |
| V_{IH} | Input HIGH Voltage | 3835 | 4050 | 4120 | 3835 | 4120 | 4120 | 3835 | 4120 | 4120 | mV |
| V_{IL} | Input LOW Voltage | 3190 | 3300 | 3525 | 3190 | 3525 | 3525 | 3190 | 3525 | 3525 | mV |
| V_{CUT} | Cut-off Output Voltage (Note 2.) | 2.9 | | 2.97 | 2.9 | | 2.97 | 2.9 | | 2.97 | V |
| I_{IH} | Input HIGH Current RXEN All Other Inputs | | | 225 150 | | | 225 150 | | | 225 150 | μA |
| I_{IL} | Input LOW Current | 0.5 | 0.3 | | 0.5 | 0.25 | | 0.5 | 0.2 | | μA |

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained.

1. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.46 V / -0.8 V.
2. Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

100E SERIES NECL DC CHARACTERISTICS $V_{CCx}=0.0\text{ V}$; $V_{EE}=-5.0\text{ V}$ (Note 1.)

| Symbol | Characteristic | 0°C | | | 25°C | | | 85°C | | | Unit |
|-----------|--|-------|-------|------------|-------|-------|-------------|-------|-------|------------|---------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I_{EE} | Power Supply Current | | 125 | 150 | | 125 | 150 | | 144 | 173 | mA |
| V_{OH} | Output HIGH Voltage (Note 2.) | -1025 | -950 | -880 | -1025 | -950 | -880 | -1025 | -950 | -880 | mV |
| V_{OL} | Output LOW Voltage (Note 2.) | -1810 | -1705 | -1620 | -1810 | -1745 | -1620 | -1810 | -1740 | -1620 | mV |
| V_{IH} | Input HIGH Voltage | -1165 | -950 | -880 | -1165 | -880 | -880 | -1165 | -880 | -880 | mV |
| V_{IL} | Input LOW Voltage | -1810 | -1700 | -1475 | -1810 | -1475 | -1475 | -1810 | -1475 | -1475 | mV |
| V_{CUT} | Cut-off Output Voltage (Note 2.) | 2.9 | | 2.97 | 2.9 | | 2.97 | 2.9 | | 2.97 | V |
| I_{IH} | Input HIGH Current RXEN All Other Inputs | | | 225 150 | | | 225 1502 | | | 225 150 | μA |
| I_{IL} | Input LOW Current | 0.5 | 0.3 | | 0.5 | 0.25 | | 0.5 | 0.2 | | μA |

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfm is maintained.

1. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.46 V / -0.8 V.
2. Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

MC10E336, MC100E336

AC CHARACTERISTICS $V_{CCx} = 5.0\text{ V}; V_{EE} = 0.0\text{ V}$ or $V_{CCx} = 0.0\text{ V}; V_{EE} = -5.0\text{ V}$ (Note 1.)

| Symbol | Characteristic | 0°C | | | 25°C | | | 85°C | | | Unit |
|------------------------|---|--------------------------|----------------------------|--------------------|--------------------------|----------------------------|--------------------|--------------------------|----------------------------|--------------------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| f_{MAX} | Maximum Toggle Frequency | | TBD | | | TBD | | | TBD | | GHz |
| t_{PLH} t_{PHL} | Propagation Delay to Output Clk to Q Clk to \overline{BUS} | 500 825 | 700 1250 | 100 1800 | 500 825 | 700 1250 | 1000 1800 | 500 825 | 700 1250 | 1000 1800 | ps |
| t_s | Setup Time $\overline{BUS}, \overline{RXEN}$ BUSEN A, B Data TEN | 150 100 300 450 | -150 -200 -50 150 | | 150 100 300 450 | -150 -200 -50 150 | | 150 100 300 450 | -150 -200 -50 150 | | ps |
| t_h | Hold Time $\overline{BUS}, \overline{RXEN}$ BUSEN A, B Data TEN | 450 500 350 200 | 150 200 50 -150 | | 450 500 350 200 | 150 200 50 -150 | | 450 500 350 200 | 150 200 50 -150 | | ps |
| t_{PW} | Minimum Pulse Width Clk | 400 | | | 400 | | | 400 | | | ps |
| t_{JITTER} | Cycle-to-Cycle Jitter | | TBD | | | TBD | | | TBD | | ps |
| t_r t_f | Rise/Fall Times 20 - 80% (Q_n) 20 - 80% (\overline{BUS}_n Rise) 20 - 80% (\overline{BUS}_n Fall) | 300 500 300 | 450 800 500 | 700 1000 800 | 300 500 300 | 450 800 500 | 700 1000 800 | 300 500 300 | 450 800 500 | 700 1000 800 | ps |

1. 10 Series: V_{EE} can vary +0.46 V / -0.06 V.
100 Series: V_{EE} can vary +0.46 V / -0.8 V.

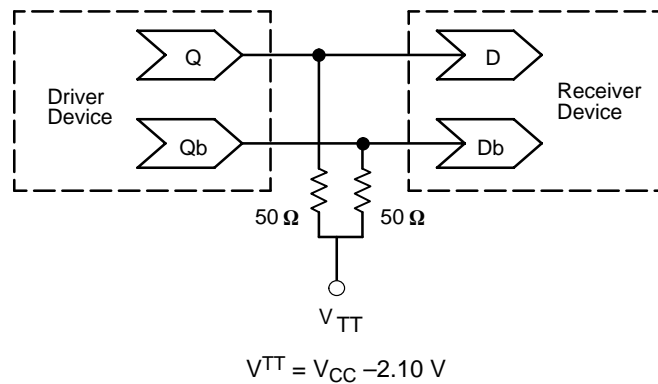


Figure 1. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020 – Termination of ECL Logic Devices.)

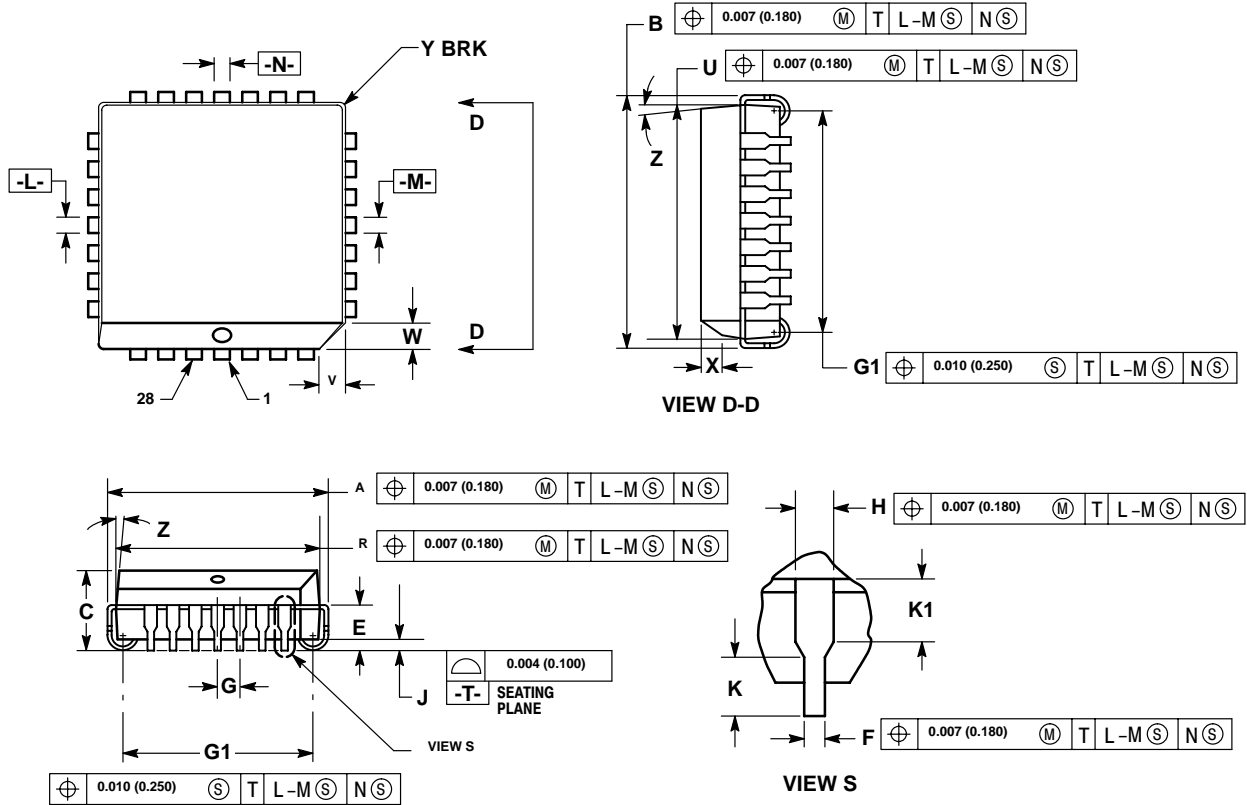
Resource Reference of Application Notes

- AN1404** – ECLinPS Circuit Performance at Non–Standard V_{IH} Levels
- AN1405** – ECL Clock Distribution Techniques
- AN1406** – Designing with PECL (ECL at +5.0 V)
- AN1503** – ECLinPS I/O SPICE Modeling Kit
- AN1504** – Metastability and the ECLinPS Family
- AN1568** – Interfacing Between LVDS and ECL
- AN1596** – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
- AN1650** – Using Wire–OR Ties in ECLinPS Designs
- AN1672** – The ECL Translator Guide
- AND8001** – Odd Number Counters Design
- AND8002** – Marking and Date Codes
- AND8020** – Termination of ECL Logic Devices

MC10E336, MC100E336

PACKAGE DIMENSIONS

PLCC-28
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776-02
ISSUE E



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIM G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIM R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.485 | 0.495 | 12.32 | 12.57 |
| B | 0.485 | 0.495 | 12.32 | 12.57 |
| C | 0.165 | 0.180 | 4.20 | 4.57 |
| E | 0.090 | 0.110 | 2.29 | 2.79 |
| F | 0.013 | 0.019 | 0.33 | 0.48 |
| G | 0.050 BSC | | 1.27 BSC | |
| H | 0.026 | 0.032 | 0.66 | 0.81 |
| J | 0.020 | — | 0.51 | — |
| K | 0.025 | — | 0.64 | — |
| R | 0.450 | 0.456 | 11.43 | 11.58 |
| U | 0.450 | 0.456 | 11.43 | 11.58 |
| V | 0.042 | 0.048 | 1.07 | 1.21 |
| W | 0.042 | 0.048 | 1.07 | 1.21 |
| X | 0.042 | 0.056 | 1.07 | 1.42 |
| Y | — | 0.020 | — | 0.50 |
| Z | 2° | 10° | 2° | 10° |
| G1 | 0.410 | 0.430 | 10.42 | 10.92 |
| K1 | 0.040 | — | 1.02 | — |

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